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PART NO. SEE TABLE 1

REVISIONS

LTR	DESCRIPTION	Drawing	DATE
A	Initial Release for Manufacture	GARY	06/01/07
B	修改圖面與實物相符	GARY	07/28/07
C	修改塑膠壁厚	GARY	09/21/07

**CUSTOMER
DRAWING**

TABLE 1

020-01-00291	15 U" GOLD	LCP BLACK	3.50
020-01-00292	15 U" GOLD	PA9T BLACK	3.50
020-01-00293	15 U" GOLD	PA9T BLACK	3.00
020-01-00294	15 U" GOLD	LCP BLACK	3.00
PART NO.	PLATED	COLOR FOR THE PLASTIC	DIM A

NOTE:

1.MATERIAL :
 HOUSING : High Temperature Thermoplastic ,
 UL94V-0, COLOR : BLACK
 TERMINAL(max): Copper Alloy,THICKNESS = 0.30 mm
 TERMINAL(min): Copper Alloy,THICKNESS = 0.25 mm
 FORKLICK: Copper Alloy,THICKNESS = 0.30 mm

2.PLATING:
 CONTACT:GOLD OVER 50u" MIN NICKEL UNDERPLATE
 SOLDER TAIL: 150u"MIN MISTY TIN 50u" MIN NICKEL UNDERPLATE
 GOLD SPECIFICATION:SEE TABLE

3.ELECTRONICAL SPECIFICATION:
 CURRENT RATING: 1.5 AMPERE PER CONTACT
 CONTACT RESISTANCE: 30 MILLIOHMS MAX.
 INSULATION RESISTANCE: 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC.
 OPERATING TEMPERATURE: -20°C~+85°C

4.MEETS THE REQUIREMENTS OF DIRECTIVE 2002/95/EC OF THE EUROPEAN PARLIAMENT AND OF THE COUNCIL OF 27 JANUARY 2003 ON THE RESTRICTION OF THE USE OF CERTAIN HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT(ROHS)

RECOMMENDED PCB LAYOUT

SECTION
B-B

DIMENSION ARE MILLIMETERS TOLERANCES ARE : DECIMALS .X ± 0.20 .XX ± 0.15 ANGLE: X ± 3°	APPROVALS		DATE	PART NO. 020-01-00291/00292 020-01-00293/00294
	DRAWN	GARY	09/21/07	
	CHECKED			
	APPROVALS			TITLE: SAS 29P Vertical DIP 3 ROWS (Without BULGE)
	SIZE	SCALE :	DRAWING NO.	REV.
	mm	1 : 1	000492	C
NO	DESCRIPTION			ID NO. XXXXXXXXXX
	Q'TY	UNIT	DO NOT SCALE DRAWING	SHEET 1 OF 1

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